



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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TECHNOLOGY CENTER 2800

In re application of:

Gu-Sung KIM

Serial No.: 10/073,173

Filed: February 13, 2002

For: WAFER LEVEL PACKAGE WITH AIR PADS
AND MANUFACTURING METHOD THEREOF

Examiner: Long Pham

Group Art Unit: 2822

Attorney Docket No.: 259/014

**AMENDMENT AND REQUEST FOR RECONSIDERATION
UNDER 37 C.F.R. §1.111**

Assistant Commissioner for Patents
United States Patent and Trademark Office
Washington, D.C. 20231

Sir:

In response to the Office Action mailed August 14, 2002, kindly amend the above-identified application as follows.

IN THE CLAIMS:

✓
Kindly cancel claims 7 - 20 without prejudice or disclaimer.